

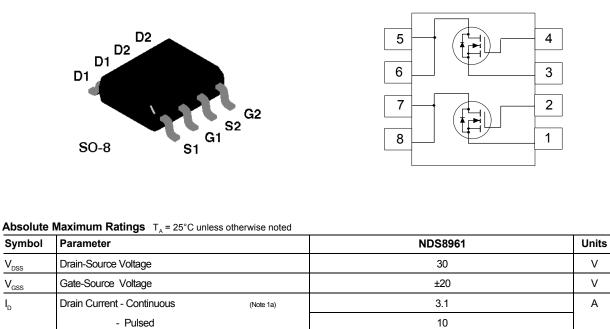
# NDS8961 Dual N-Channel Enhancement Mode Field Effect Transistor

## **General Description**

SO-8 N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance and provide superior switching performance. These devices are particularly suited for low voltage applications such as DC motor control and DC/DC conversion where fast switching, low in-line power loss, and resistance to transients are needed.

## Features

- 3.1 A, 30 V.  $R_{DS(ON)} = 0.1 \Omega @ V_{GS} = 10 V R_{DS(ON)} = 0.15 \Omega @ V_{GS} = 4.5 V.$
- High density cell design for extremely low R<sub>DS(ON)</sub>.
- High power and current handling capability in a widely used surface mount package.
- Dual MOSFET in surface mount package.

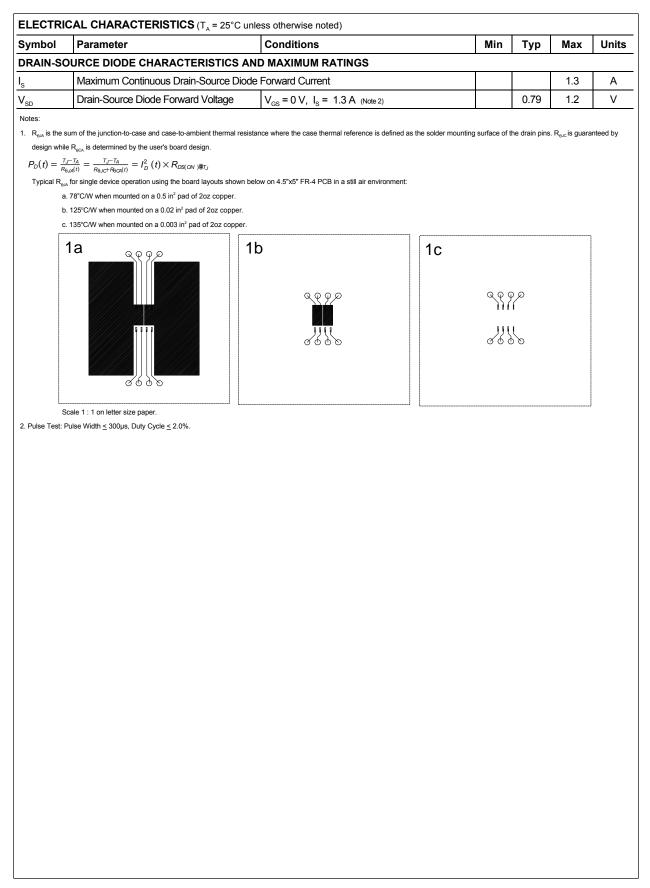


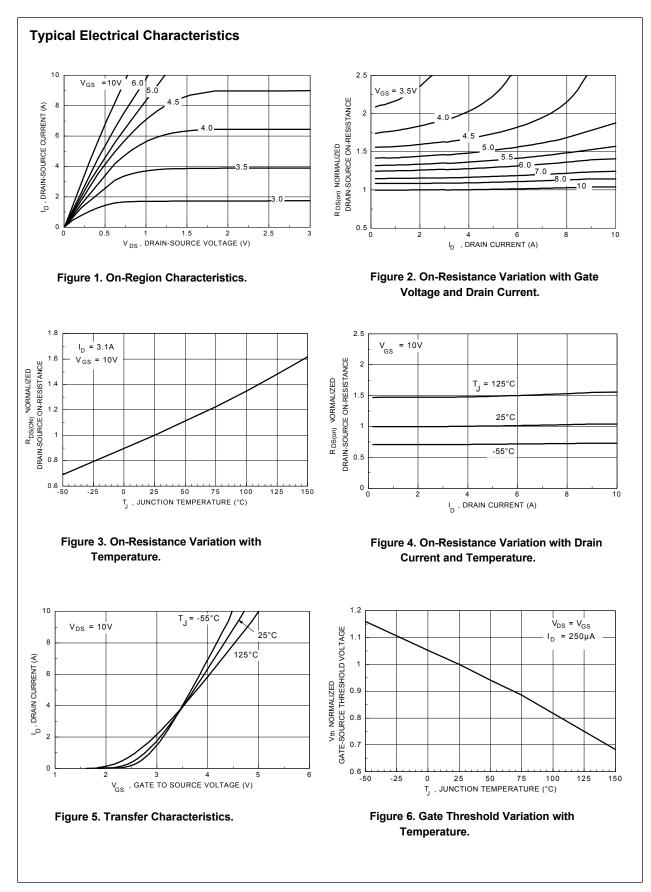
Drain Current - Continuous	(Note 1a)	3.1	A
- Pulsed		10	
Power Dissipation for Dual Operation		2	W
Power Dissipation for Single Operation	(Note 1a)	1.6	
	(Note 1b)	1	
	(Note 1c)	0.9	
Operating and Storage Temperature Range		-55 to 150	°C
L CHARACTERISTICS			
Thermal Resistance, Junction-to-Ambient	(Note 1a)	78	°C/W
Thermal Resistance, Junction-to-Case	(Note 1)	40	°C/W
	- Pulsed      Power Dissipation for Dual Operation      Power Dissipation for Single Operation      Operating and Storage Temperature Range      L CHARACTERISTICS      Thermal Resistance, Junction-to-Ambient	- Pulsed      Power Dissipation for Dual Operation      Power Dissipation for Single Operation     (Note 1a)     (Note 1b)     (Note 1c)      Operating and Storage Temperature Range  L CHARACTERISTICS  Thermal Resistance, Junction-to-Ambient (Note 1a)	- Pulsed     10       Power Dissipation for Dual Operation     2       Power Dissipation for Single Operation     (Note 1a)       (Note 1b)     1       (Note 1c)     0.9       Operating and Storage Temperature Range     -55 to 150       L CHARACTERISTICS     Thermal Resistance, Junction-to-Ambient (Note 1a)     78

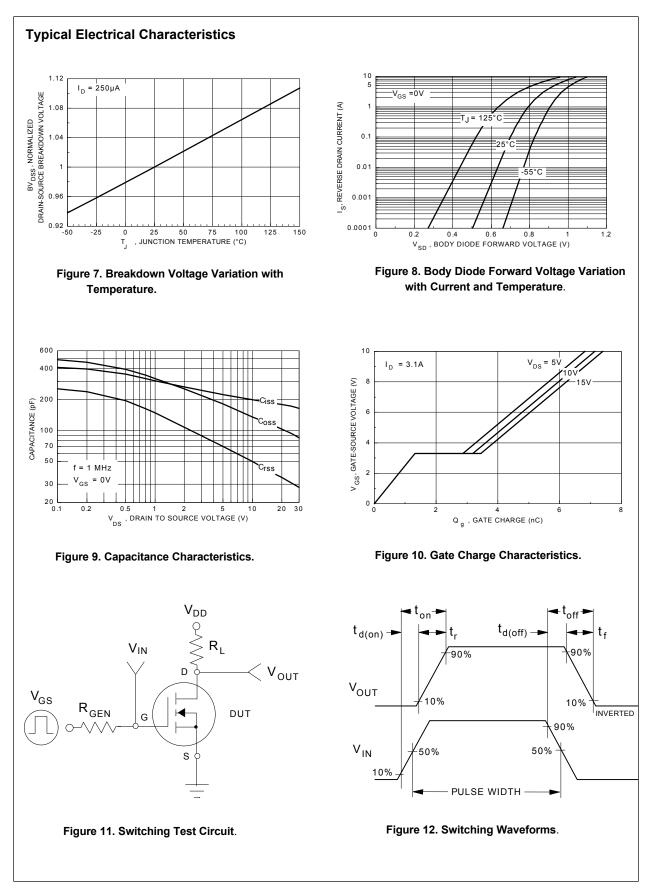
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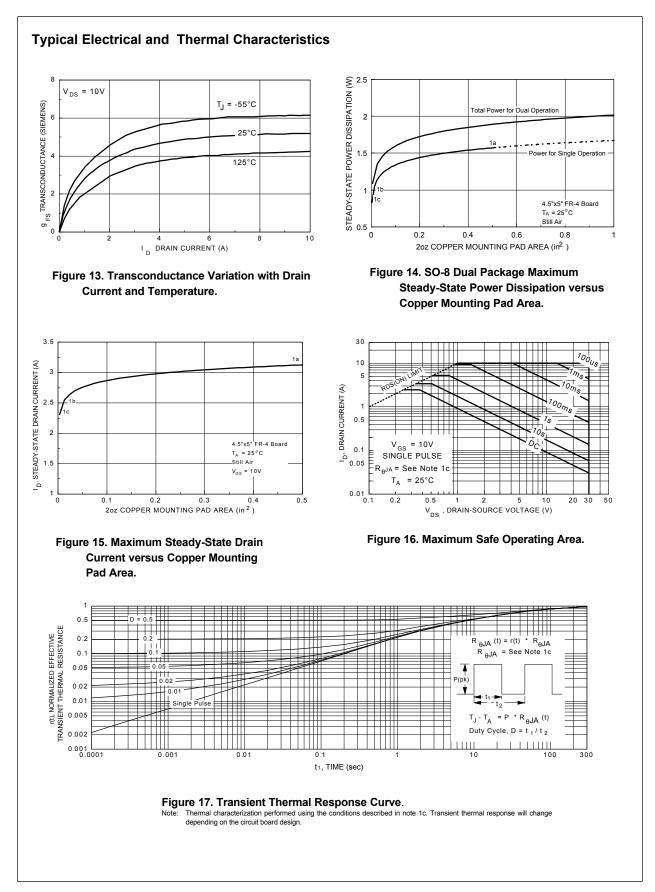
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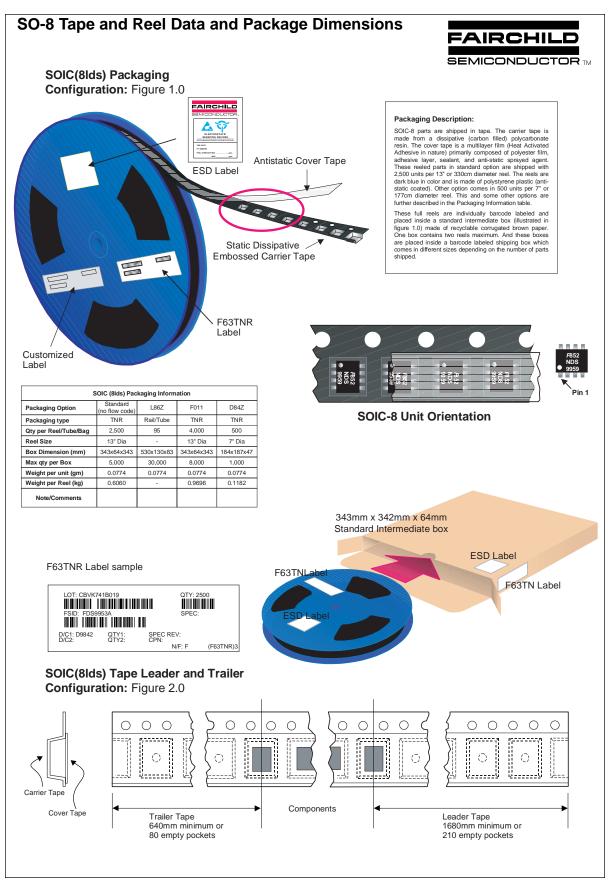
Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHA	RACTERISTICS						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 250 μA		30			V
I <sub>DSS</sub> Zero Gate Voltage Drain Current	V <sub>DS</sub> = 24 V, V <sub>GS</sub> = 0 V				1	μA	
			T <sub>J</sub> = 55°C			10	μA
I <sub>GSSF</sub>	Gate - Body Leakage, Forward	V <sub>GS</sub> = 20 V, V <sub>DS</sub> = 0 V				100	nA
I <sub>GSSR</sub>	Gate - Body Leakage, Reverse	V <sub>GS</sub> = -20 V, V <sub>DS</sub> = 0 V				-100	nA
ON CHAR	ACTERISTICS (Note 2)						
V <sub>GS(th)</sub> Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$		1	1.6	3	V	
		T <sub>J</sub> = 125°C	0.7	1.2	2		
R <sub>DS(ON)</sub> Static Drain-Source On-Resistance	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}, I_{D} = 3.1 \text{ A}$			0.072	0.1	Ω
		T <sub>J</sub> = 125°C		0.107	0.18		
	$V_{GS} = 4.5 \text{ V}, I_{D} = 2.6 \text{ A}$			0.116	0.15		
I <sub>D(on)</sub> On-State Drain Current	$V_{GS}$ = 10 V, $V_{DS}$ = 5 V		10			Α	
		$V_{GS} = 4.5 V, V_{DS} = 5 V$		4			
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 3.1 \text{ A}$			4.3		S
DYNAMIC	CHARACTERISTICS						
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 15 V, V_{GS} = 0 V,$ f = 1.0 MHz			190		pF
C <sub>oss</sub>	Output Capacitance				120		pF
C <sub>rss</sub>	Reverse Transfer Capacitance				40		pF
SWITCHIN	IG CHARACTERISTICS (Note 2)						
t <sub>D(on)</sub>	Turn - On Delay Time	$V_{DD} = 10 V, I_D = 1 A,$ $V_{GS} = 10 V, R_{GEN} = 6 \Omega$			7	15	ns
ţ,	Turn - On Rise Time				15	30	ns
t <sub>D(off)</sub>	Turn - Off Delay Time				14	28	ns
t <sub>r</sub>	Turn - Off Fall Time				3	6	ns
Q <sub>g</sub>	Total Gate Charge	$V_{DS} = 10 V,$			7.1	10	nC
$Q_{gs}$	Gate-Source Charge	$I_{\rm D} = 3.1 \text{ A}, V_{\rm GS} = 10 \text{ V}$			1.2		nC
$Q_{gd}$	Gate-Drain Charge				1.9		nC



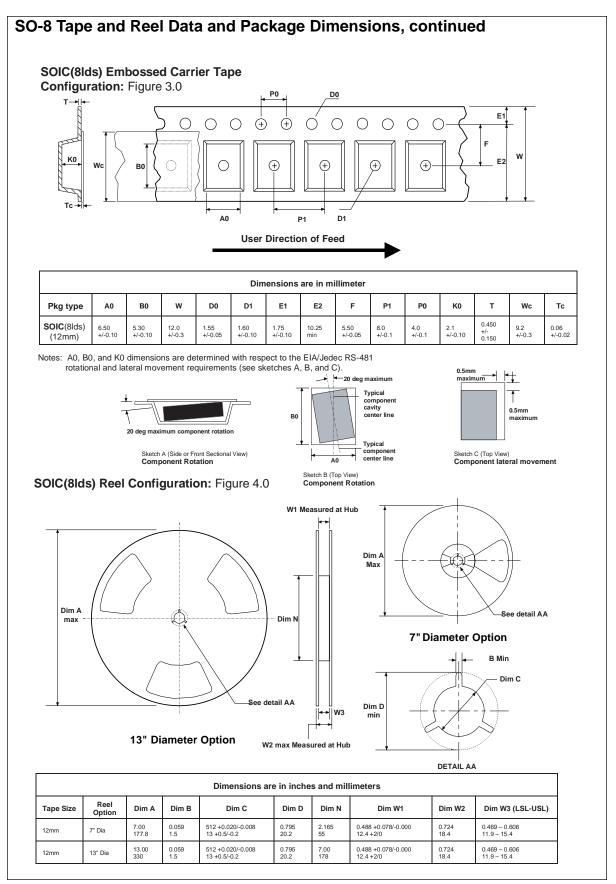


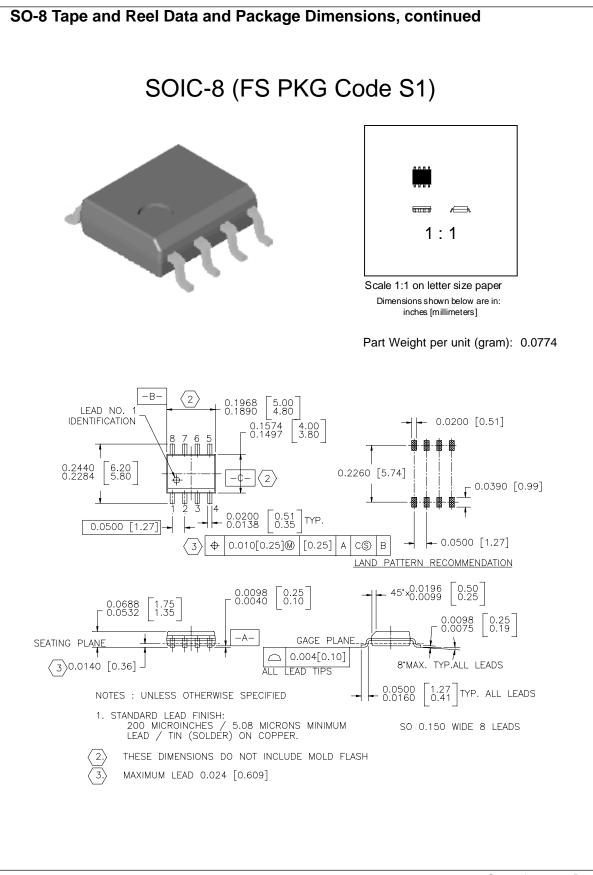






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